Manufacturing Info MBOI Specifications

PH4 ISPL (ATEC) (CU) MBOI Data

Supply
<u>Purchasing/Payables</u> Planning APSFR

Factory Information
Capacity Statement
Quality
Global EBR5 External Manufacturing MPE

Data Exchange Document and Data Exchange Intransit Exceptions

Search Files: 74VHC164MTCX-IPN Search MBOI Masters ASY (850) MEF (4) TST (925) Open Compliance (832)

Search text is highlighted in RED 74VHC164MTCX-IPN

Manufacturing Bill of Information (MBOI)						
Part Number	74VHC164MTCX-IPN-ASY	Part Type	Assembly Part			
Site   Name   Loc Cod	PH4   ISPL (ATEC)   CU	File Name	PH4_74VHC164MTCX-IPN_74VHC164MTCX-IPN-ASY_ASY			
Flags	Non Safe Launch Item No Global Hold Flag	Part Qual Target Market:	I   Industrial			
Part Version	4	Part Version Date-Time	2024-MAY-05 05:43:15 (GMT +7)			

Orderable Part Section - OPN					
Part Number   Desc	74VHC164MTCX-IPN   8-BIT SIPO SHIFT REG	Market PN	74VHC164MTCX-IPN		
Lifecycle Phase	Production	Part Class   Desc	AA   ASSEMBLED AND TESTED		
Marketing Product Lifecycle	Follow Part Lifecycle	Part Sub Type	OPN		
Part Release Status   Desc	MC-M   Mass Production	Part Usage	STD		
Case Outline (CO)	948G PP	PAL4 Code   Desc			
Product Data Sheet					
ERP Resource Code - ASY   Desc	F304   TSSOP14 AU SNGL HPBF	OPN Part Qual Target Market	I   Industrial		
Packing Configuration	TSSOP-14_948G_REEL_2500_FBQ5000	Eng Package Type	TSSOP-14		

Assembly_Part_Section - ASY				
Part Number	74VHC164MTCX-IPN-ASY	Description	8-BIT SIPO SHIFT REG	
Lifecycle Phase	Production	Part Usage	STD	
Part Release Status   Desc	MC-M   Mass Production	Part Sub Type	ASY	
PAL4 Code   Desc	I	ERP Resource Code - ASY   Desc	F304   TSSOP14 AU SNGL HPBF	
Part Qual Target Market	I   Industrial			
Case Outline (CO)	948G <b>DP</b>	Package Type	TSSOP-14	
ECAT Override		Actual Lead Count	14	
Package Assembly Platform	SOSM - Small Outline Surface Mount	Assembly Baseline Spec		
Assembly Process Flow Spec		Assembly Spec(s) - Global		
Lot Processing Restrictions	Standard	Package Substrate Layout(s)		
ITAR Part Flag	N	Customs Configuration	8542.39.0001	
Customs ECCN Code	EAR99	Customer Consigned Flag	N	
Compressed?		Compressed Part Number		
Wettable Process Type		Wettable Flank Flag		
Site Notes				

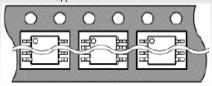
BOM Components									
Alternate 002	Part Number	Part Number Part Sub Type Line Preference Group Qty Description Lifecycle Pha							
Primary Die 74VHC164-YAC3026D-WDQ WDQ WDQ		WDQ	001	01	0	1	Wafer 200	Production	
	Die Size (X + Y W/Scribe Street):	880 x 800					PDPW : 39795		
Package Kit	N17608G030	PKT	002	01	0	1	PKGKIT TSSOP14 CU (PH4)	Production	
	Piece Parts								
	1360100014	FRAME	010	01	0	1	LF TSSOP 14L JEDEC 4.4MM STAMPED PPF	Production	
	13601510002	EPXY	020	01	0	1	DA HE QMI519 2.5CC/5CC	Production	
	WIRE	030	01	0	1	BW Au 0.8 MIL	Production		
1360191000 MOLD 040 01 0 1 MC HITACHI CE							MC HITACHI CEL800JF 13MMX5.3G	Production	
BOI 67-Bonding Diagram	67AON20154G B	DOC	003	01	0	1	74VHC164x Series	Production	

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Standard Marking Flag			
PB Free Mark Character Flag			
Consolidated Mark Machine Std		Consolidated Mark Machine Custom	Line1: \$Y&Z&2&K Line2: V164 Line3: UNK Line4: UNK Line5: UNK
	Marking Details Se	ection	

Marking Details Section					
Date Code Type S2					
Trace Code Legend - Front					
Trace Code Legend - Back					
Trace Code Spec	12MON45426G BD	Part Marking Source			
Part Marking Image/CAD Document		Marking Style Image Document			
Custom Logo Document		ON Logo Document			
Final Test Specification	48AON61241H O				

OPN Packing Section						
PCQ Container   Desc	REEL   Tape and Reel	PCQ Quantity	2500			
MPQ Container   Desc	REEL   Tape and Reel	MPQ Quantity	2500			
Intermediate Full Box Container Type   Intermediate Box Container Size   Intermediate Full Box Container Quantity	       5000	Intermediate Full Bag Container Type   Intermediate Bag Container Size   Intermediate Full Bag Container Quantity	I			

Pin 1 Toward Upper Left



Labeling Section						
MSL	1	MSL Temperature	260			
Pb Free Leads Flag	Υ	Halide Free Flag	Υ			
Pb Free Die Attach Flag	Υ	Lead Finish Category (eCAT)	e4			

Document Group Section					
Document Num	Revision	Release Date	Title		
12MON01117D	AC	15-Nov-23	Quality Assurance Inspection and Testing Sample Plan		
12MON03769D	Υ	04-Jul-22	External Visual Inspection Criteria		
12MON45426G	BD	02-Feb-23	Mark Layout Instructions		
12MON49004E	AD	14-Apr-23	Subcontractors Bar Code Labeling		
12MRB17500B	FM	19-Sep-23	Finished Goods Packing and Long Term Storage Procedure		
12MRM92695A	AE	27-Feb-24	Lot Combination Control Requirements for onsemi		
48AON61241H	0	05-Feb-24	74VHCxx, 74LCXxx & 74LVXxx Series		
67AON20154G	В	02-Feb-24	74VHC164x Series		

BOM Links					
Up/Down Direction	Site	Top Part	Link		
Up	PH4	74VHC164MTCX-IPN	PH4_74VHC164MTCX-IPN_74VHC164MTCX-IPN-TST_TST.XML		

	Revision History					
Rev	Rev Date	Details				
4	2024-FEB-21 11:06:12	LIFECYCLE_PHASE CONFIRM_REQUIRED previous_value:Prototype;new_value:Production LIFECYCLE_PHASE CONFIRM_REQUIRED previous_value:Prototype;new_value:Production PART_REL_DATE_PROD UPDATE_FILE_AND_VERSION previous_value:NULL;new_value:21-FEB-24				
3	2024-FEB-05 15:10:08	CONTROLLING_DOC UPDATE_FILE_AND_VERSION previous_value:48AON88777F;new_value:48AON61241H				

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2	2024-JAN-23 15:05:39	MARK_STYLE_SPEC_UPDATE_FILE_AND_VERSION previous PB_FREE_DIE_ATTACH_FLG_CONFIRM_REQUIRED previous PB_FREE_IND_G_CD_IND_UPDATE_FILE_AND_VERSION PB_FREE_LEADS_FLG_CONFIRM_REQUIRED previous_va	ous_value:NULL;new_value:Y previous_value:NULL;new_value:None
		PIN1_IND UPDATE_FILE_AND_VERSION previous_value:NI POLARITY_IND UPDATE_FILE_AND_VERSION previous_value:NI STD_MARK_FLG UPDATE_FILE_AND_VERSION previous_value:NI	ULL;new_value:N/A alue:NULL;new_value:NA
1	2024-JAN-18 00:03:52	Initial version	

About onsemi	Investor Relations	News & Media
Locations	Governance	Press Announcements
Leadership	Financials	In The News
Corporate Fact Sheet	Events	Blog
Quality and Reliability	News	Media Contacts
Ecosystem Partners	Stock Info	
Intellectual Property	FAQ	
Our History		
Careers		
Experienced Careers		
Early Careers		
Search & Apply		
Internships		
Who We Are		
Career Benefits		
Where We Are		



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